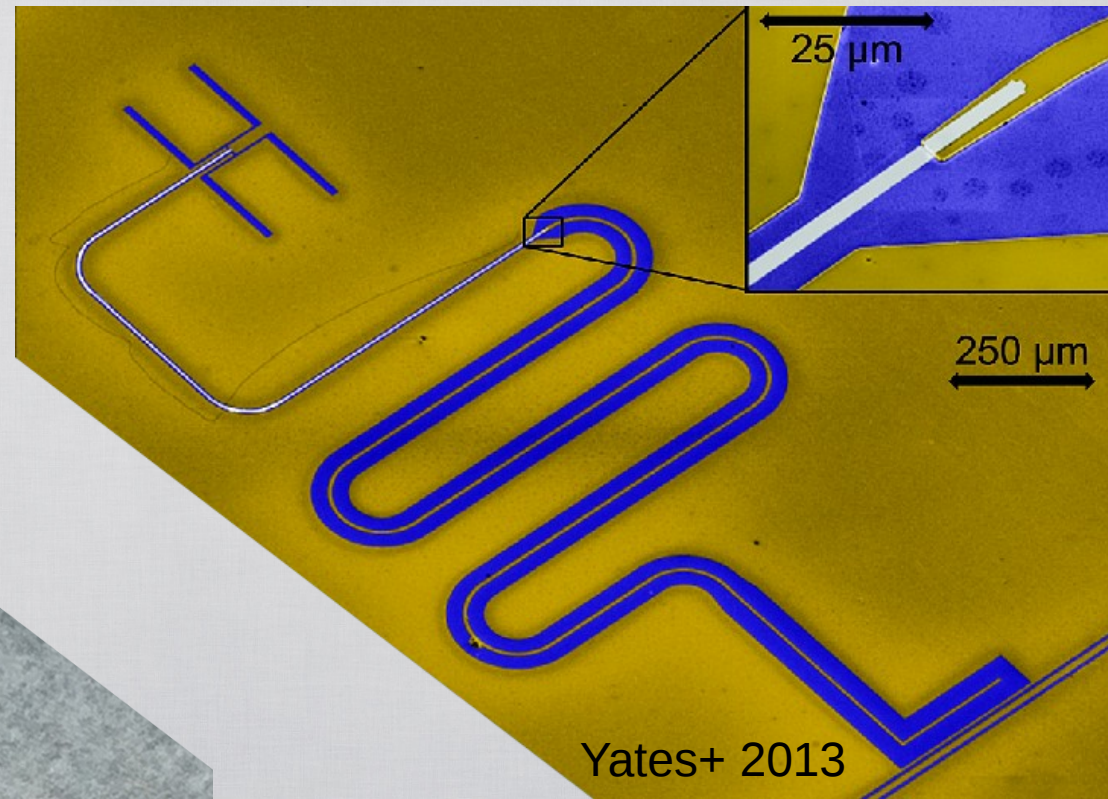
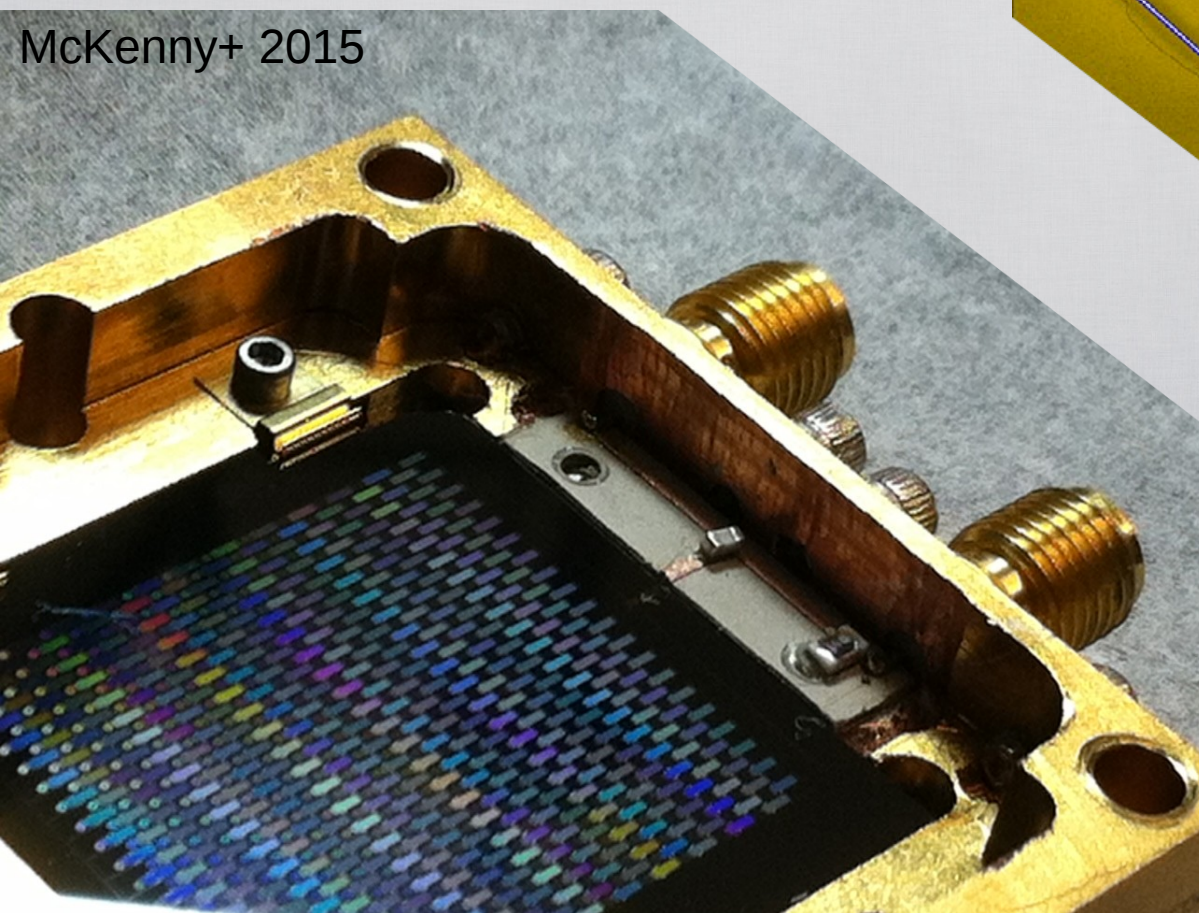


Technology for next-generation submm and far-IR instruments

Erik Shirokoff

University of Chicago

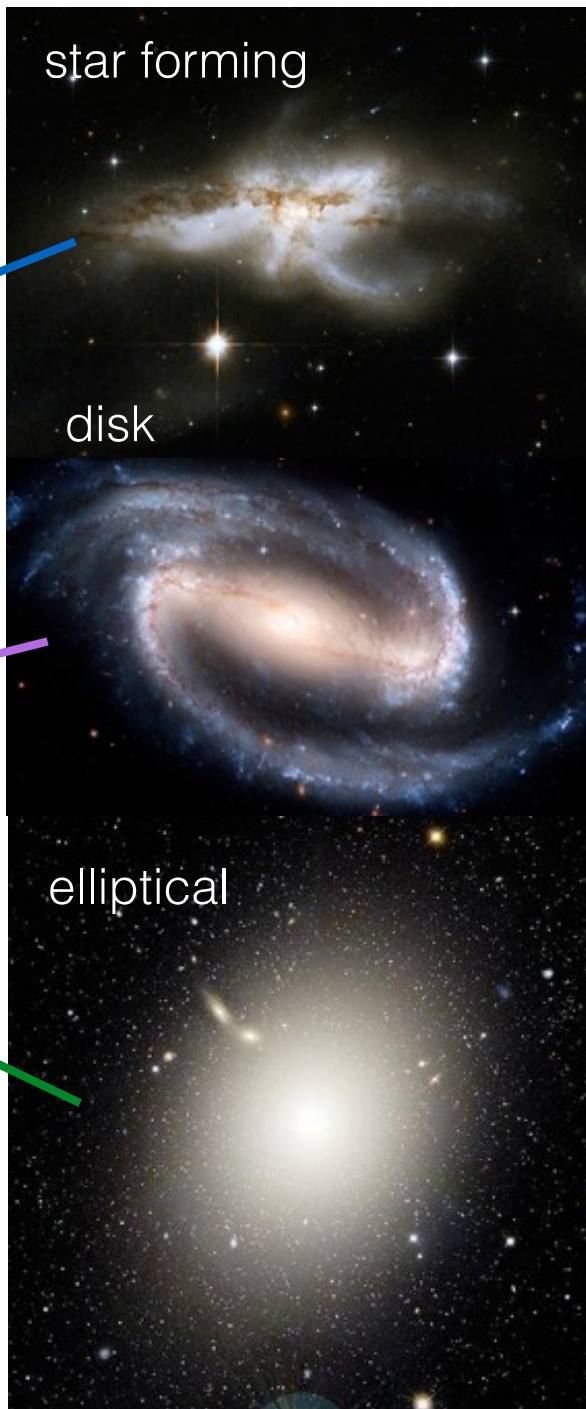
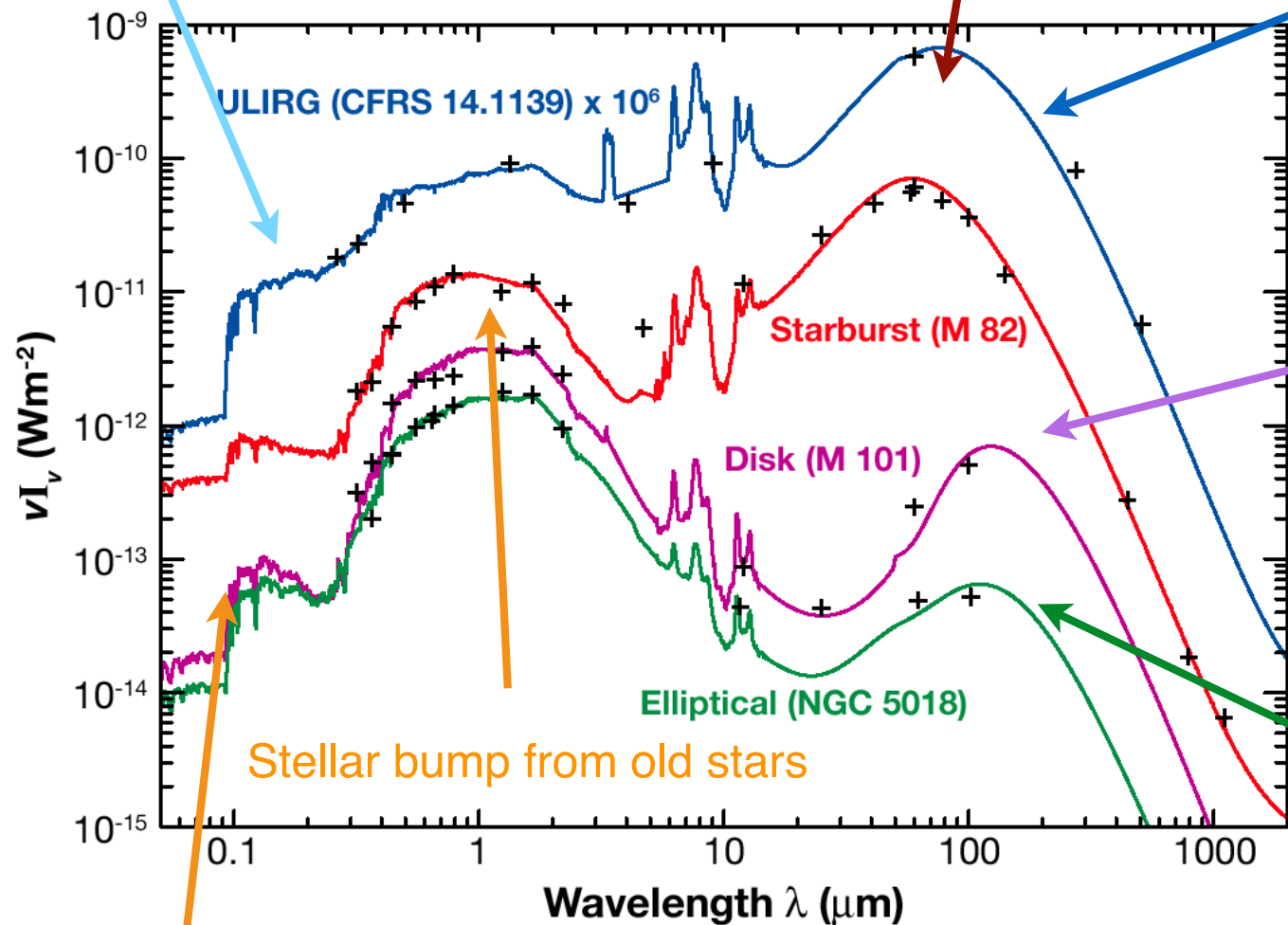


8 January, 2019

Spectral Energy Densities of Galaxies

UV radiation absorbed by dust

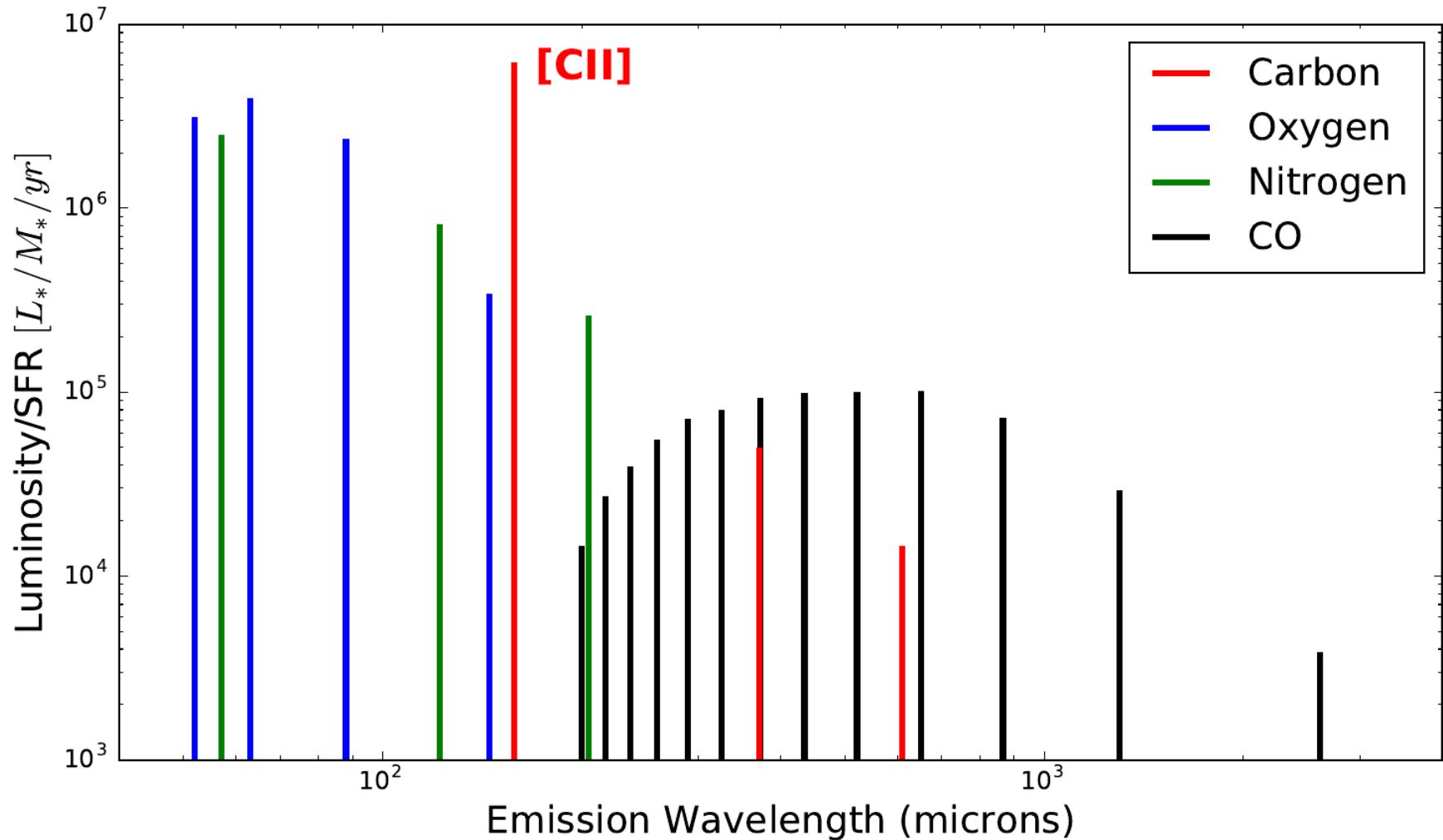
Dust re-emits in the FIR



UV from young, hot stars

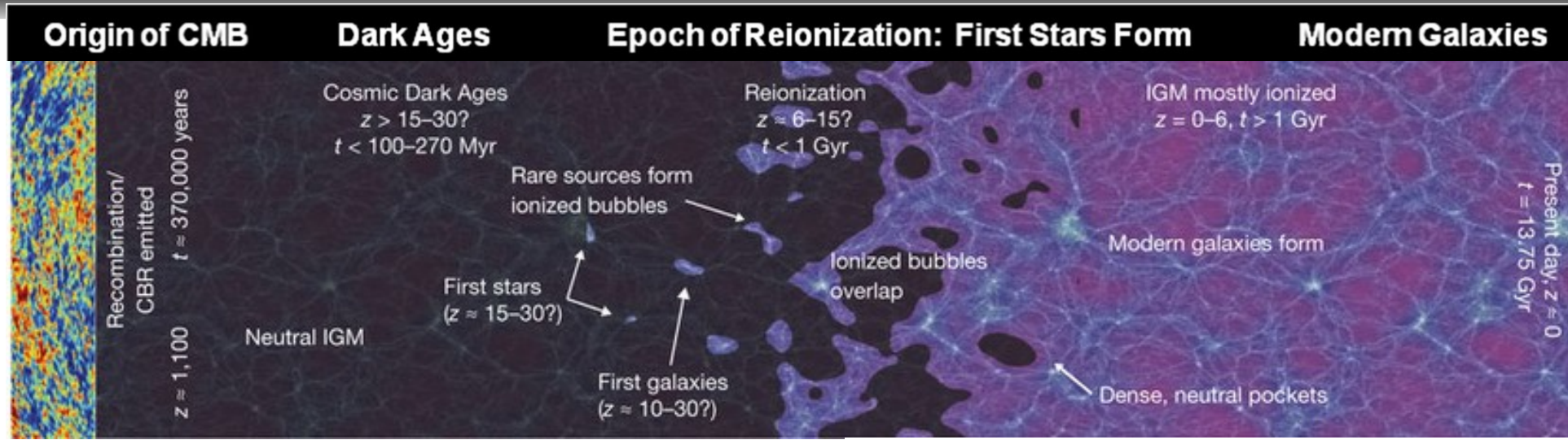
Lagach+2005, based on Galliano 2007, adapted by J. Viera

There are bright atomic and molecular lines at submm wavelengths

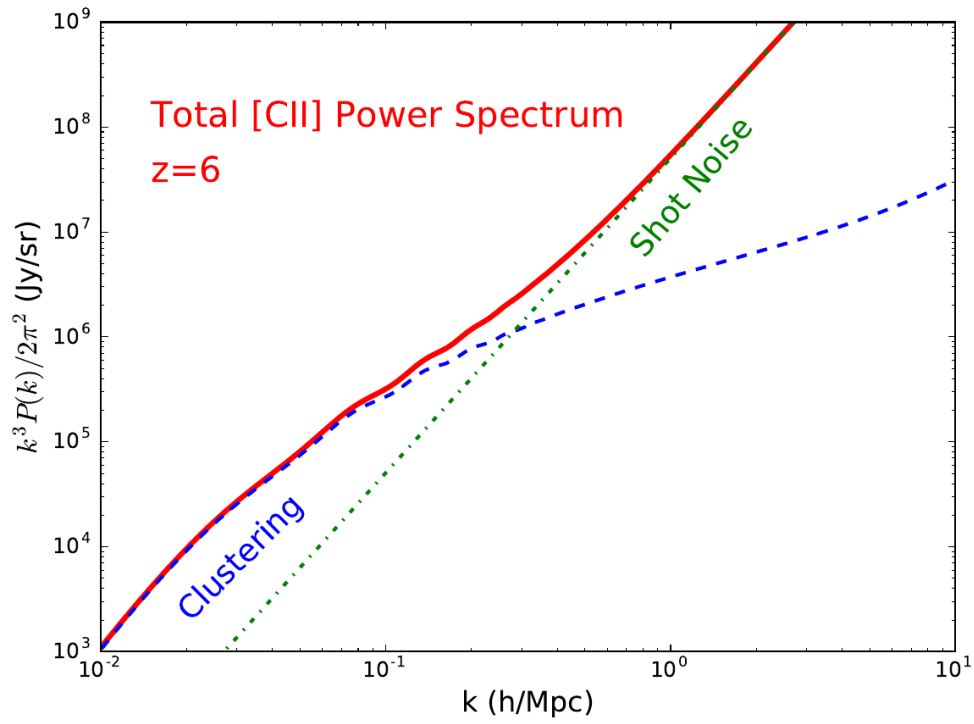
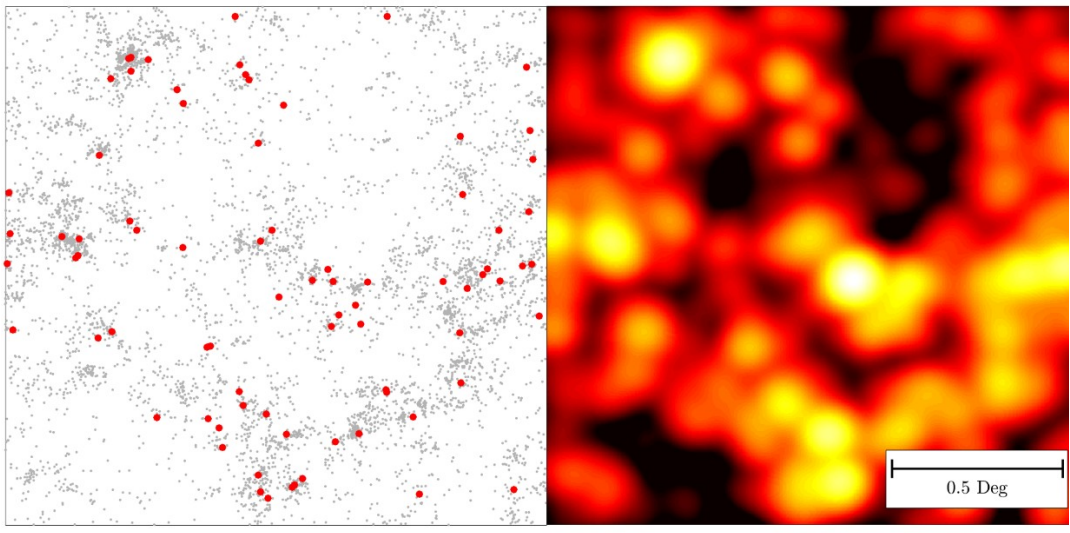


FIR line luminosities (nearby galaxies) adapted from Visbal and Loeb 2010. Figure by K. Karkare

Intensity mapping: total star formation rate, clustering, and the epoch of reionization



Dunlop & McLure



Submm survey science and tomography requires many very sensitive pixels.

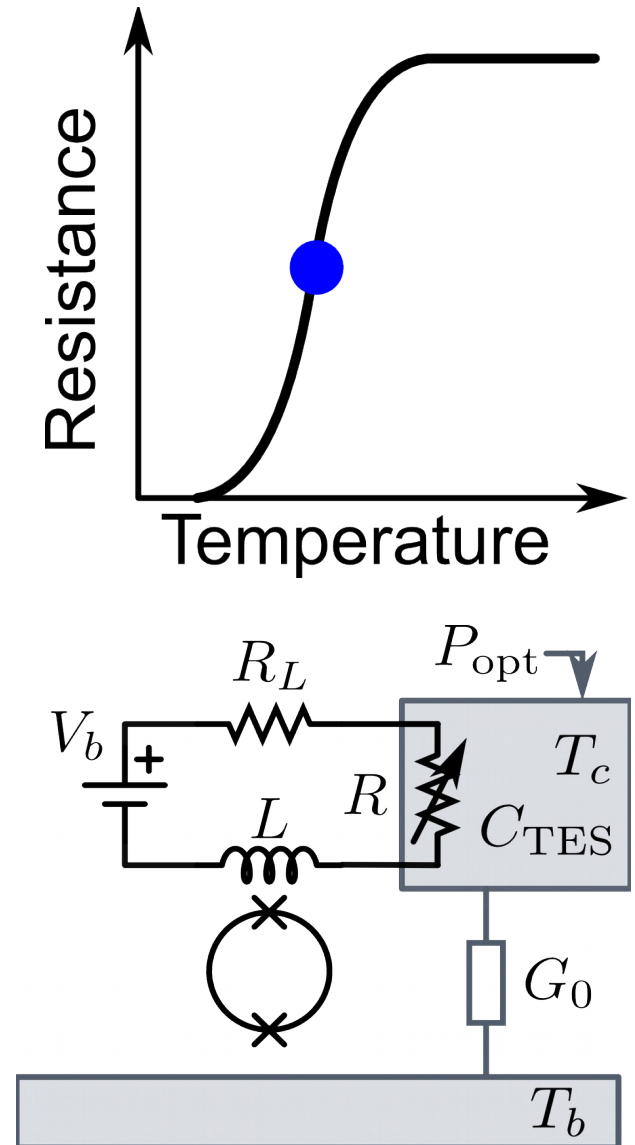
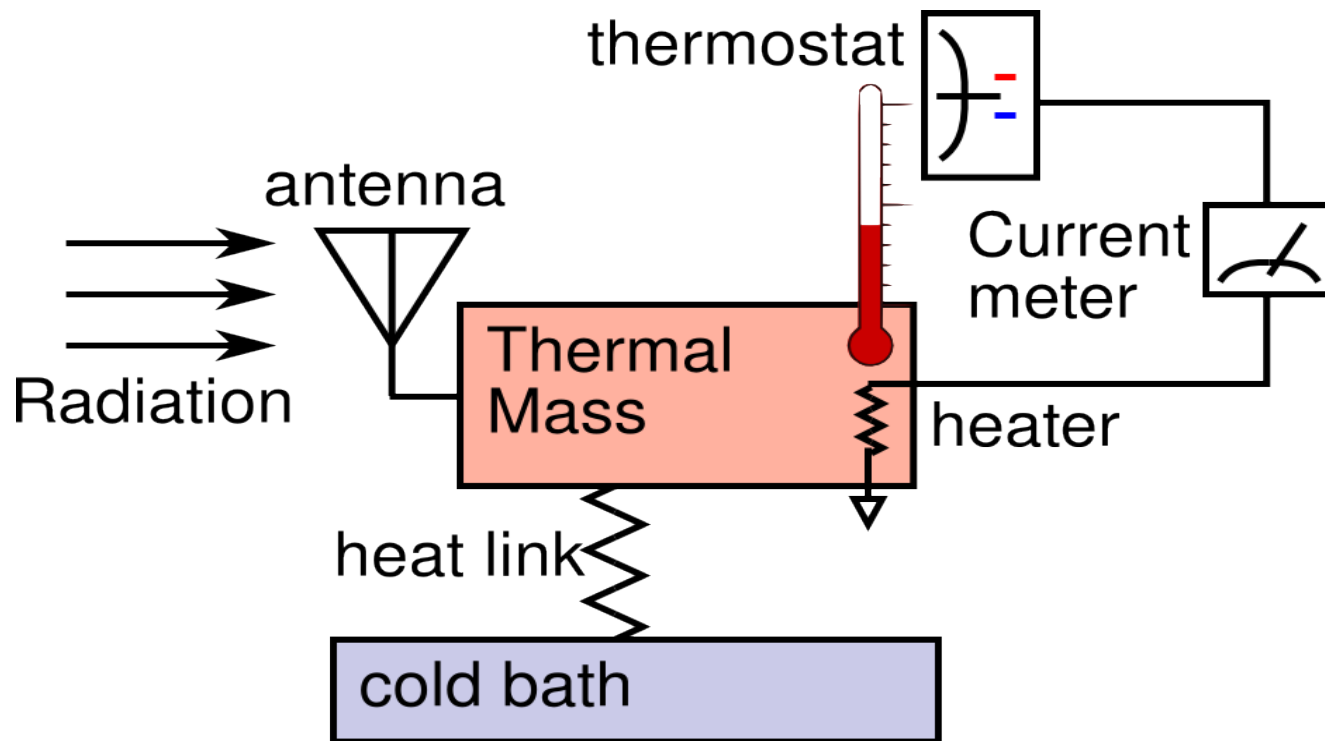
New developments in sub-K incoherent detectors:

- Bolometers and multiplexing
- Kinetic inductance detectors
- On-chip submm architecture

Note there are many exciting new things I'm skipping today:

- Coherent receivers
- Semiconductor devices
- Fourier Transform spectroscopic instruments

Bolometers: measure how much heat is deposited in a thermally-isolated material.

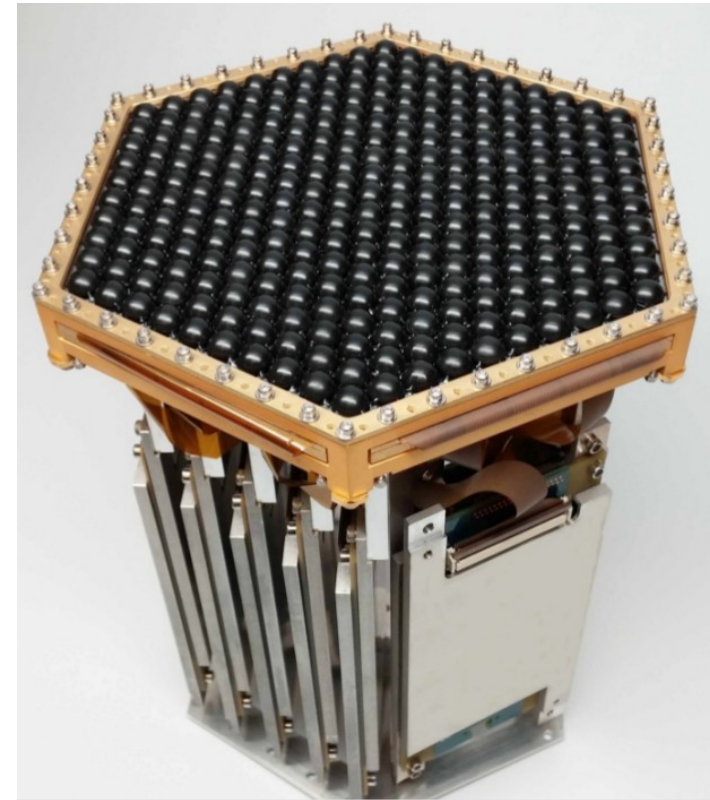


New readout schemes allow for much denser readout multiplexing of TES devices.

- Microwave frequency domain mux:
 - AC bias TESes at tens to hundreds of MHz
- Microwave mux:
 - The DC current through a resonator-coupled SQUID change the phase of a microwave tone
 - Currently planned for the Simons Observatory.

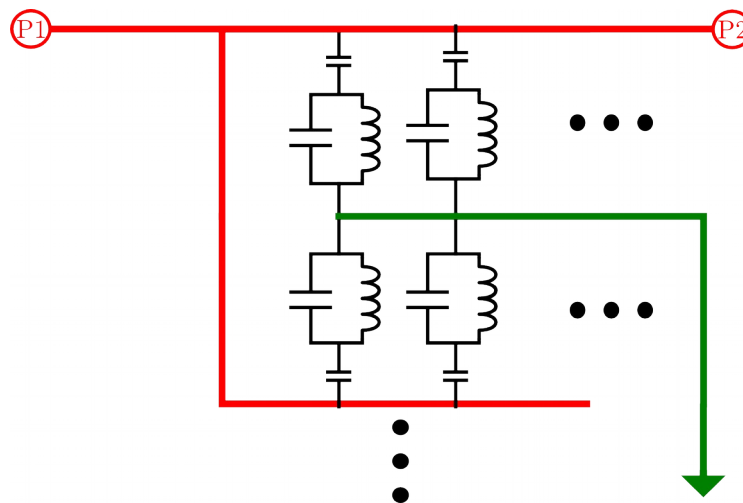
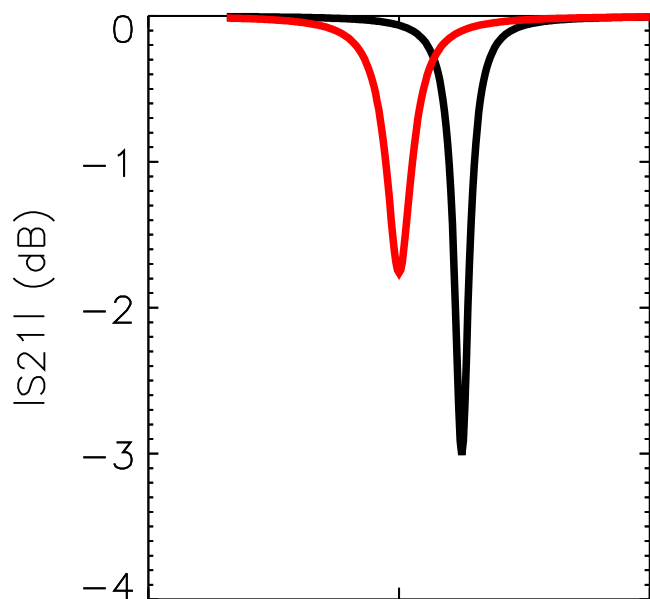
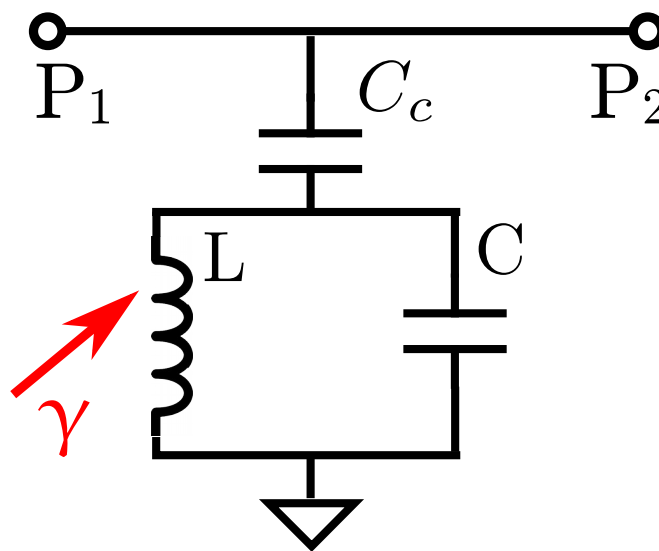
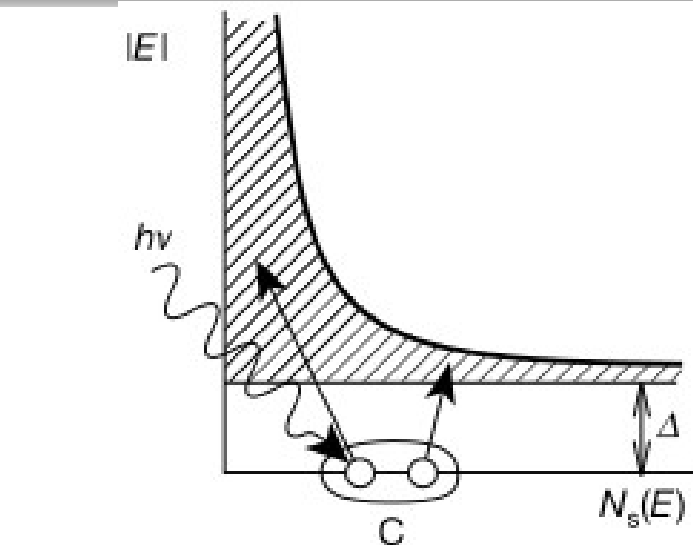
SPT-3G fielded 16000 pol-sensitive, 3-color detectors.

CMB-S4 plans to field half a million!



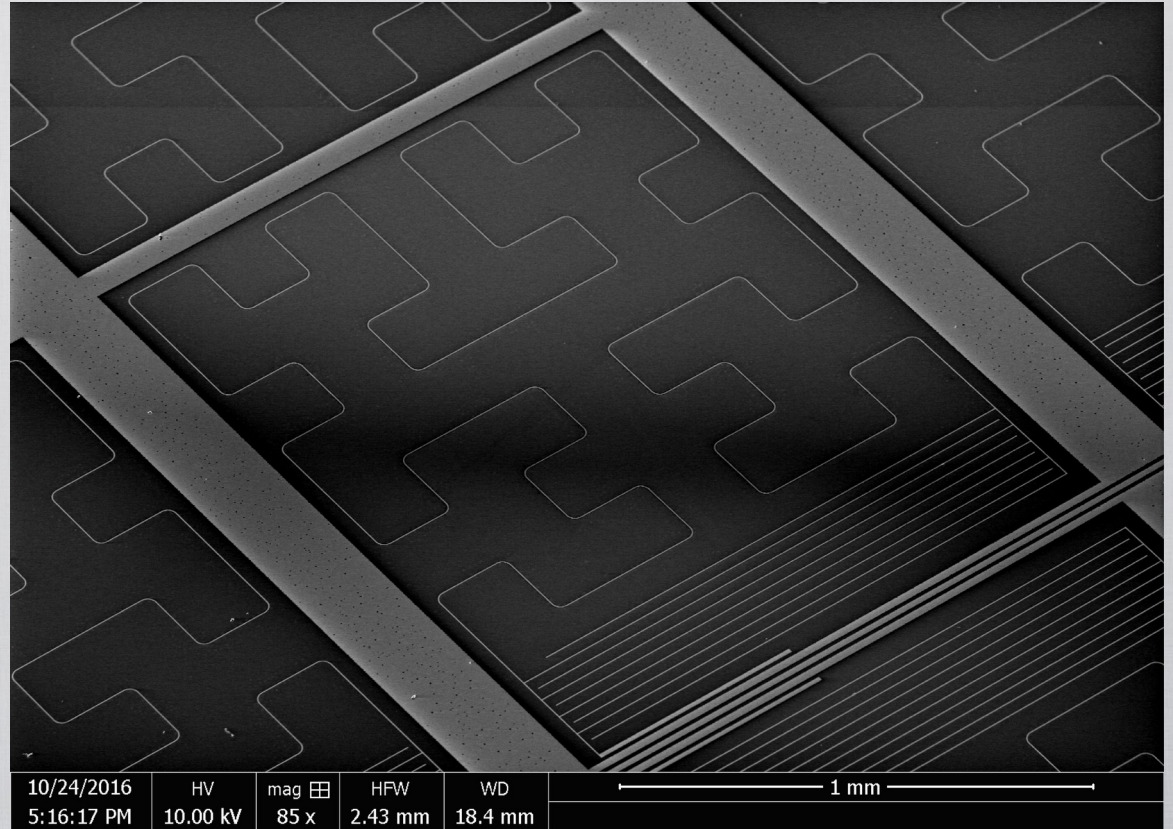
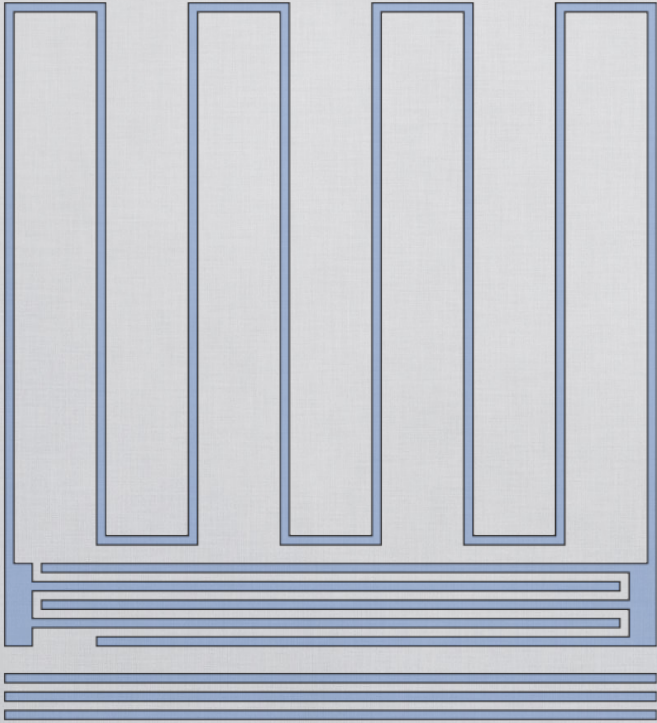
PolarBear-2 module

The kinetic inductance detector: photon absorption breaks Cooper pairs, causes a frequency shift in a microwave resonator.



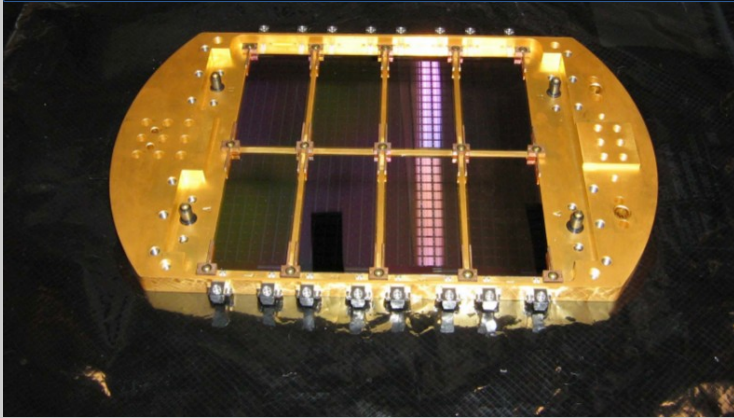
Some figures: Zmuidzinas group

Direct-absorbing lumped-element KID (LeKID): interdigitated capacitor and meandered inductor

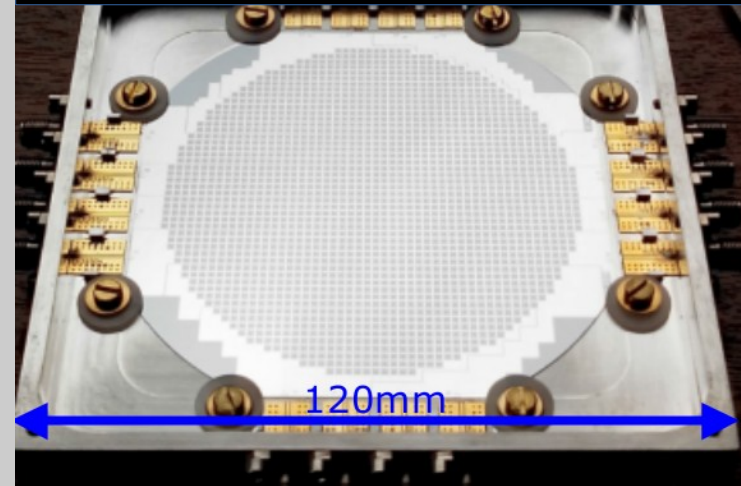


On-sky cameras exist, and many more are coming next year!

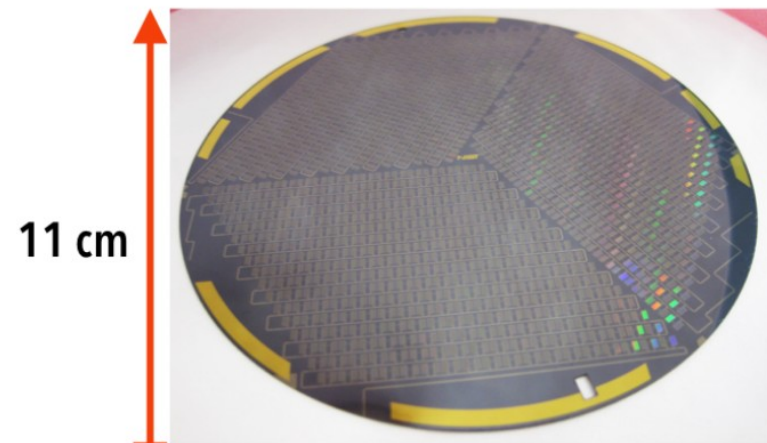
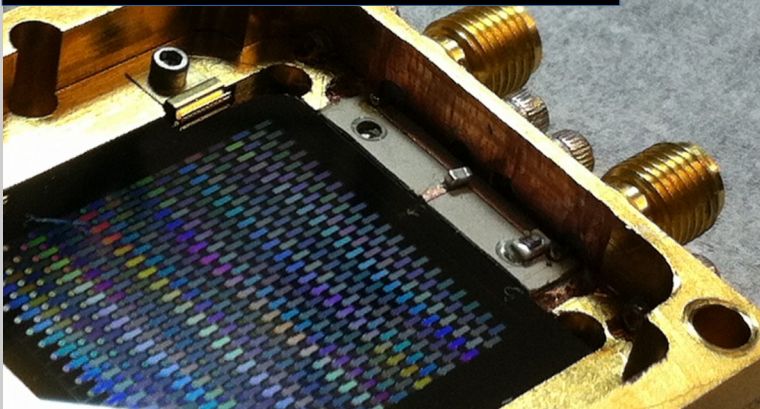
MUSIC: CSO 2012-2015
576 4-color pixels, 2mm-850 μ m



NIKA / NIKA2 (IRAM 2011-pres.)
300/5000 1.25 and 2mm pixel



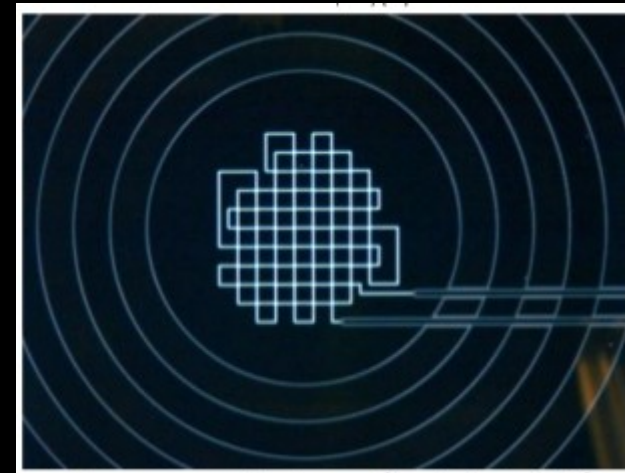
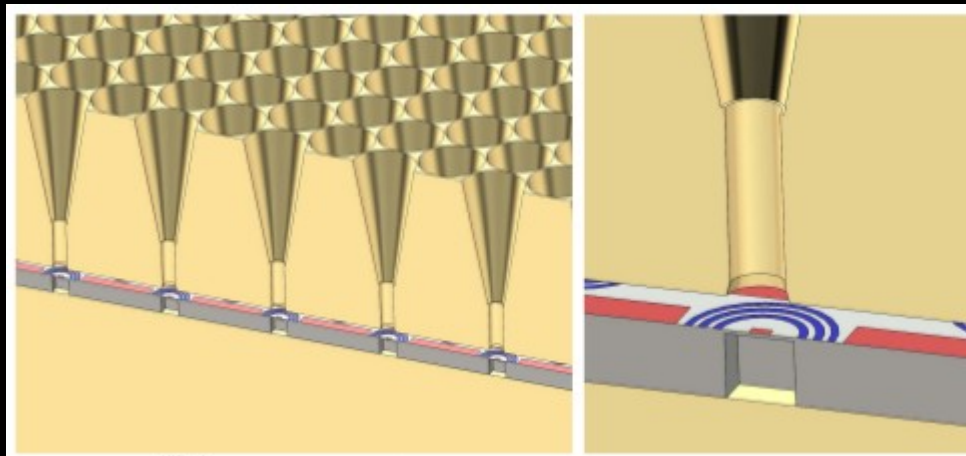
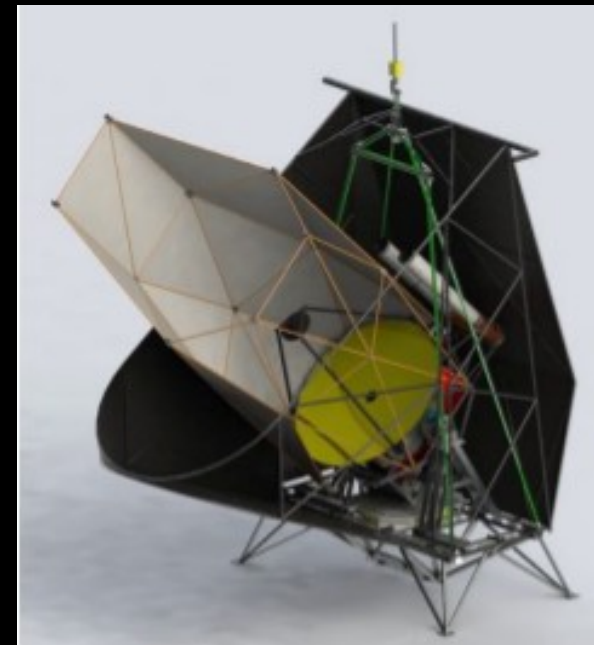
MAKO (CSO 2015)
500 pixel, 350 or 850 μ m



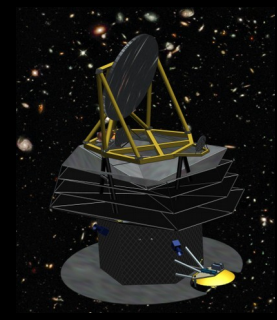
BLAST TNG (Antarctic balloon)
3300 detectors 250, 350, 500 μ m

STARFIRE: the Spectroscopic Terahertz Airborne Receiver for Far-InfraRed Exploration

- Balloon, based on BLAST gondola
- IFU grating spectrometer
- 240 to 420 micron
- Direct-absorber KID detectors

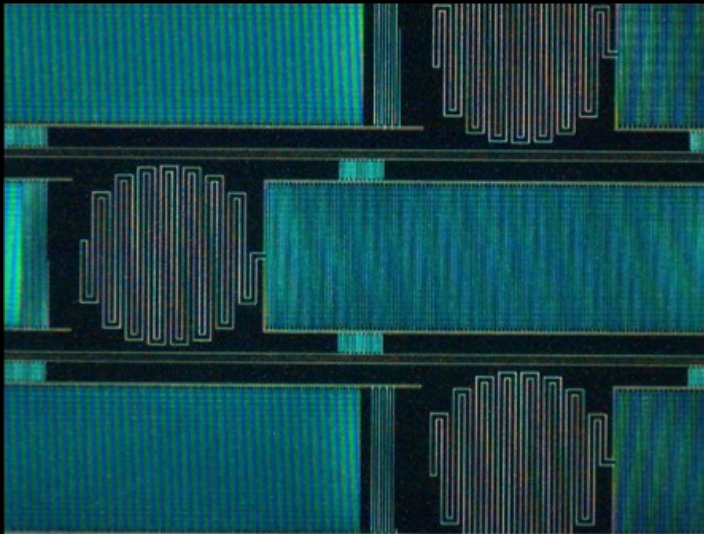


Galaxy Evolution Probe KIDs

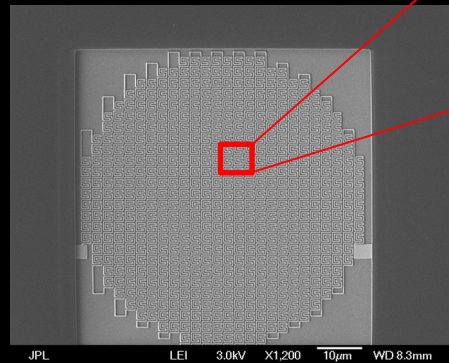


- 50,000 KIDs split evenly between imager and spectrometer
- Why baseline KIDs?
 - Simple architecture, simple cryogenic readout, one focal plane technology for all wavelengths.

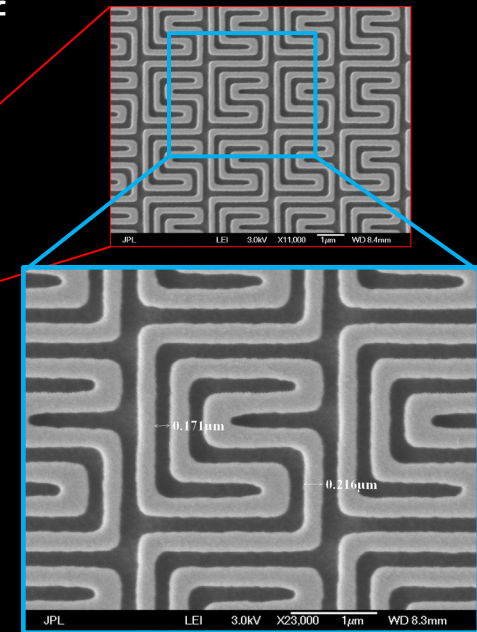
100 - 400 μm : MAKO type LEKID



10 - 95 μm : Unit cell of mid-IR KID absorber.

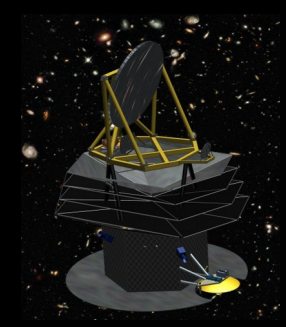


Day, LeDuc, Fyhrie, Glenn,
Perido, Zmuidzinas

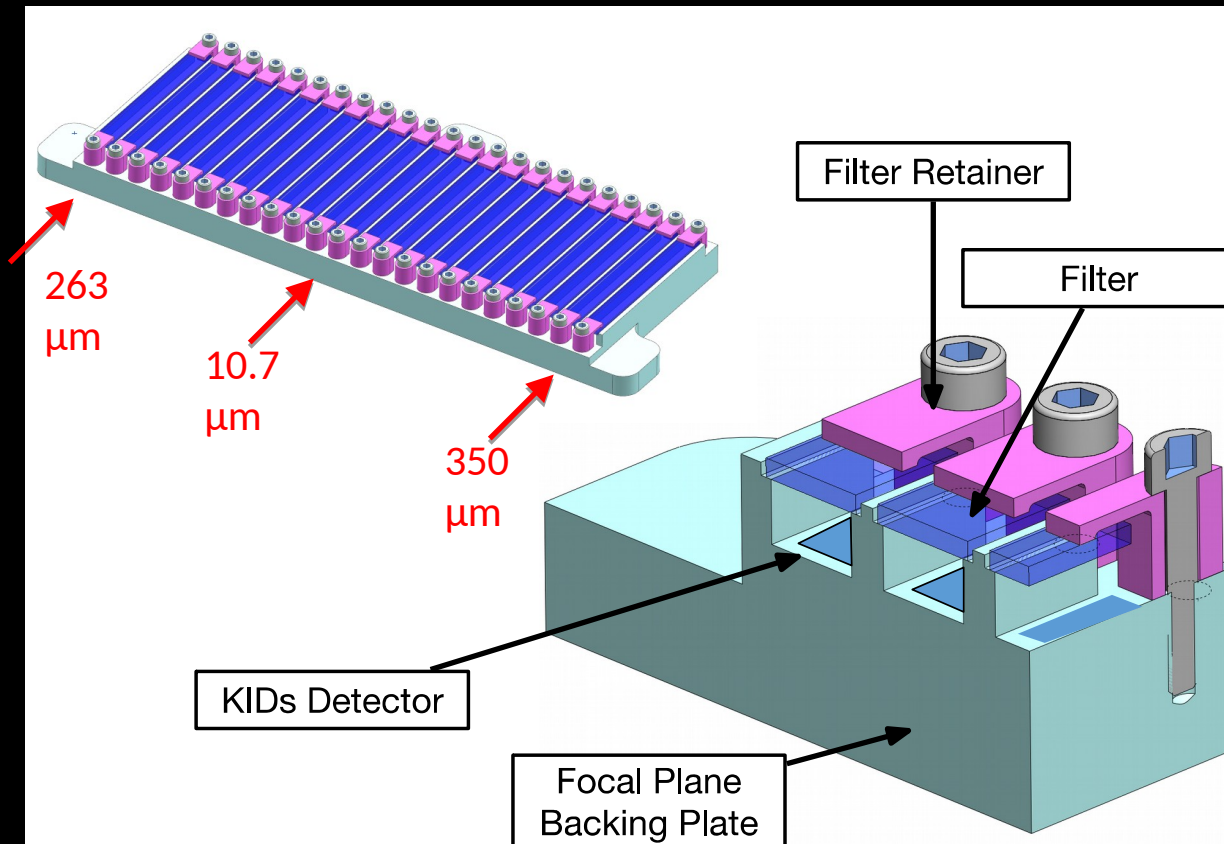


Technology development plan: MIR KIDs (10 – 100 μm),
readout

GEP-I Focal Plane (KIDs)



Continuous scanning for full spectral coverage



Spectral Resolution

10-95 μm :

$$R = \lambda/\Delta\lambda = 8$$

95-400 μm :

$$R = \lambda/\Delta\lambda = 3.5$$

FoV and Sampling

$0.5^\circ \times 0.1^\circ$

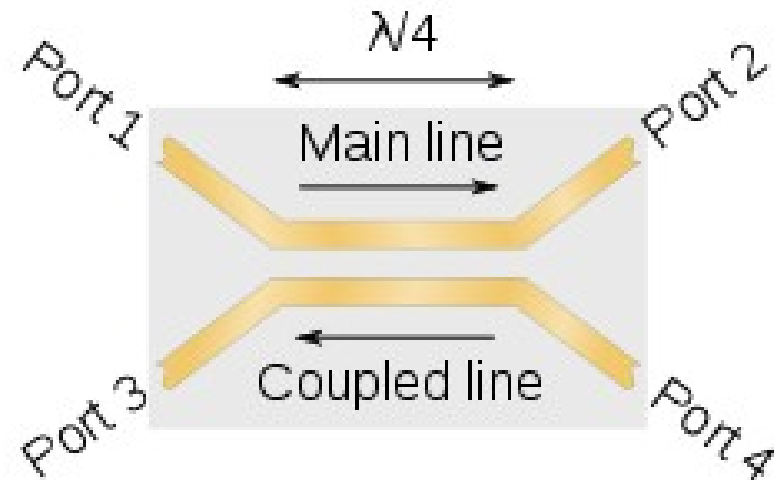
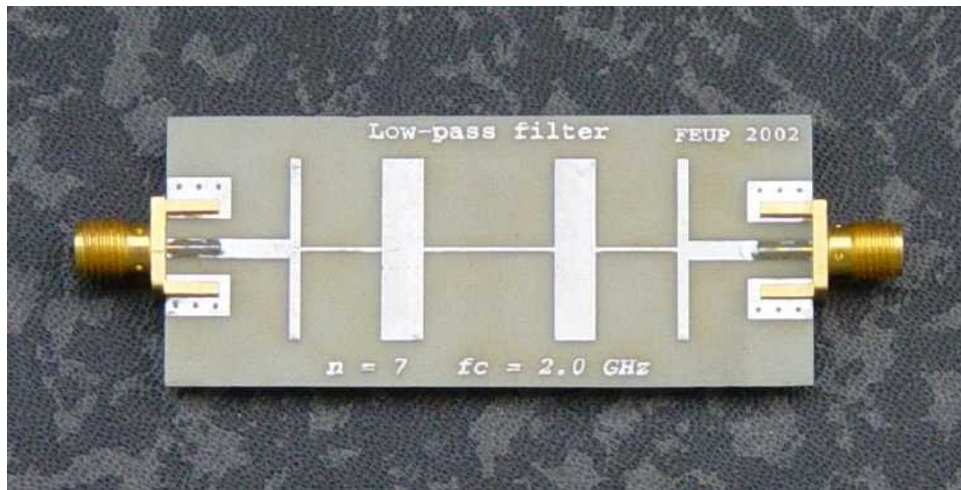
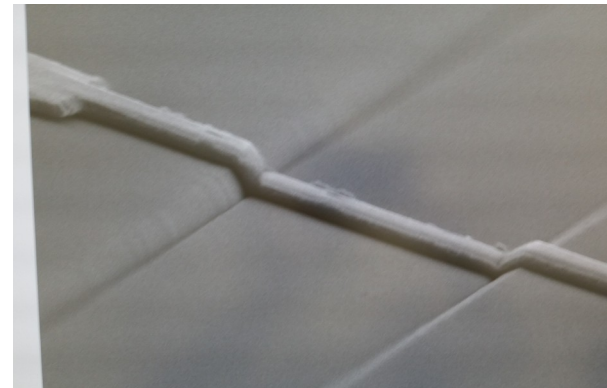
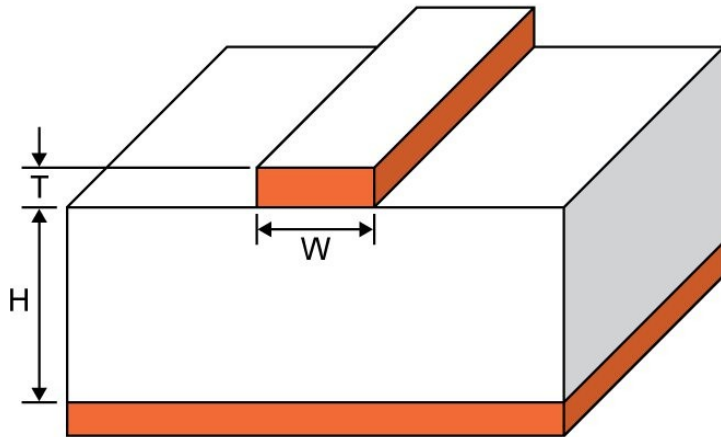
$\lambda < 70 \mu\text{m}$:

3.43'' pixels

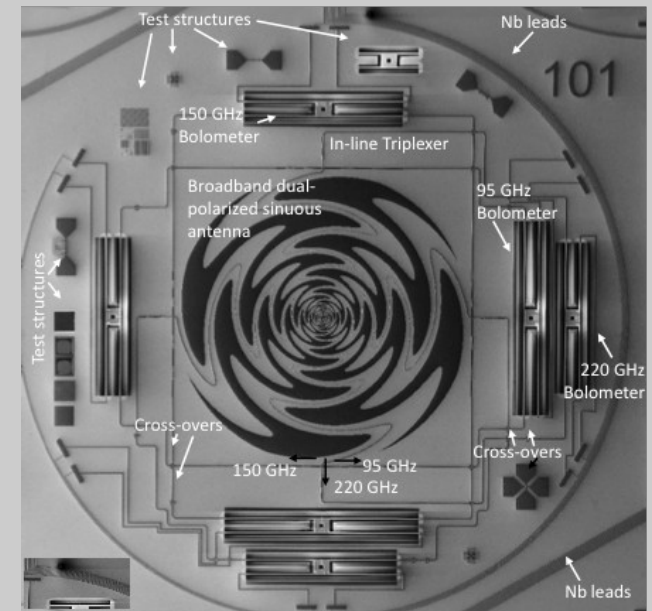
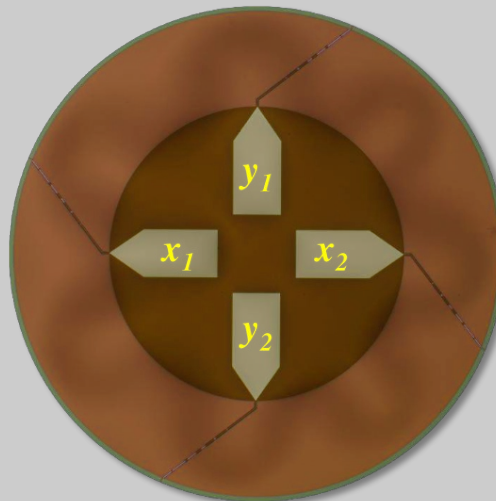
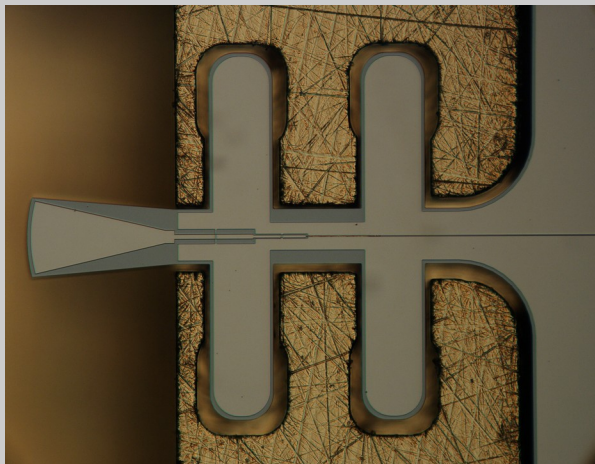
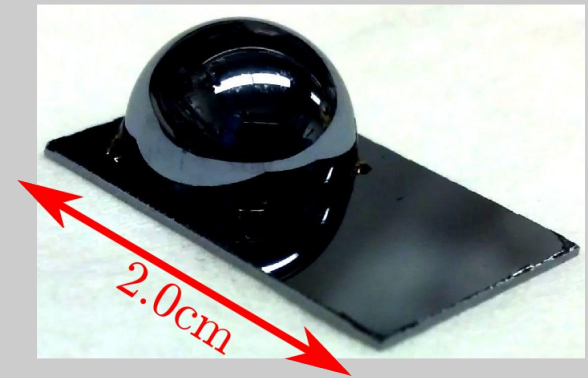
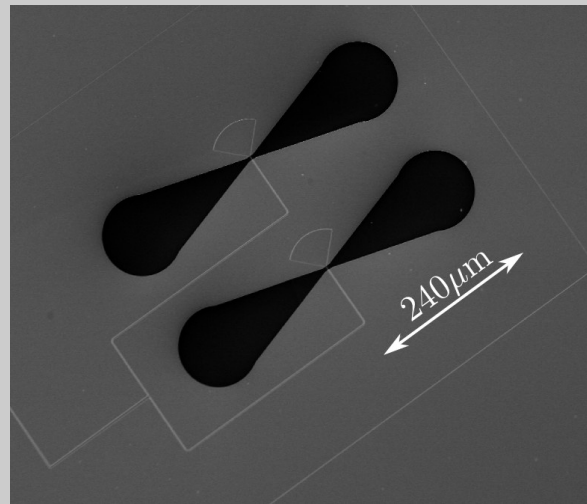
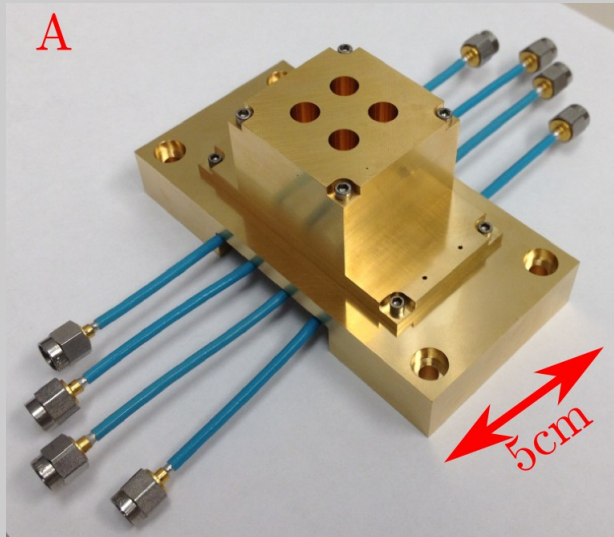
$\lambda > 70 \mu\text{m}$:

Nyquist

Tools: microwave transmission lines for submm-wavelength on-chip features

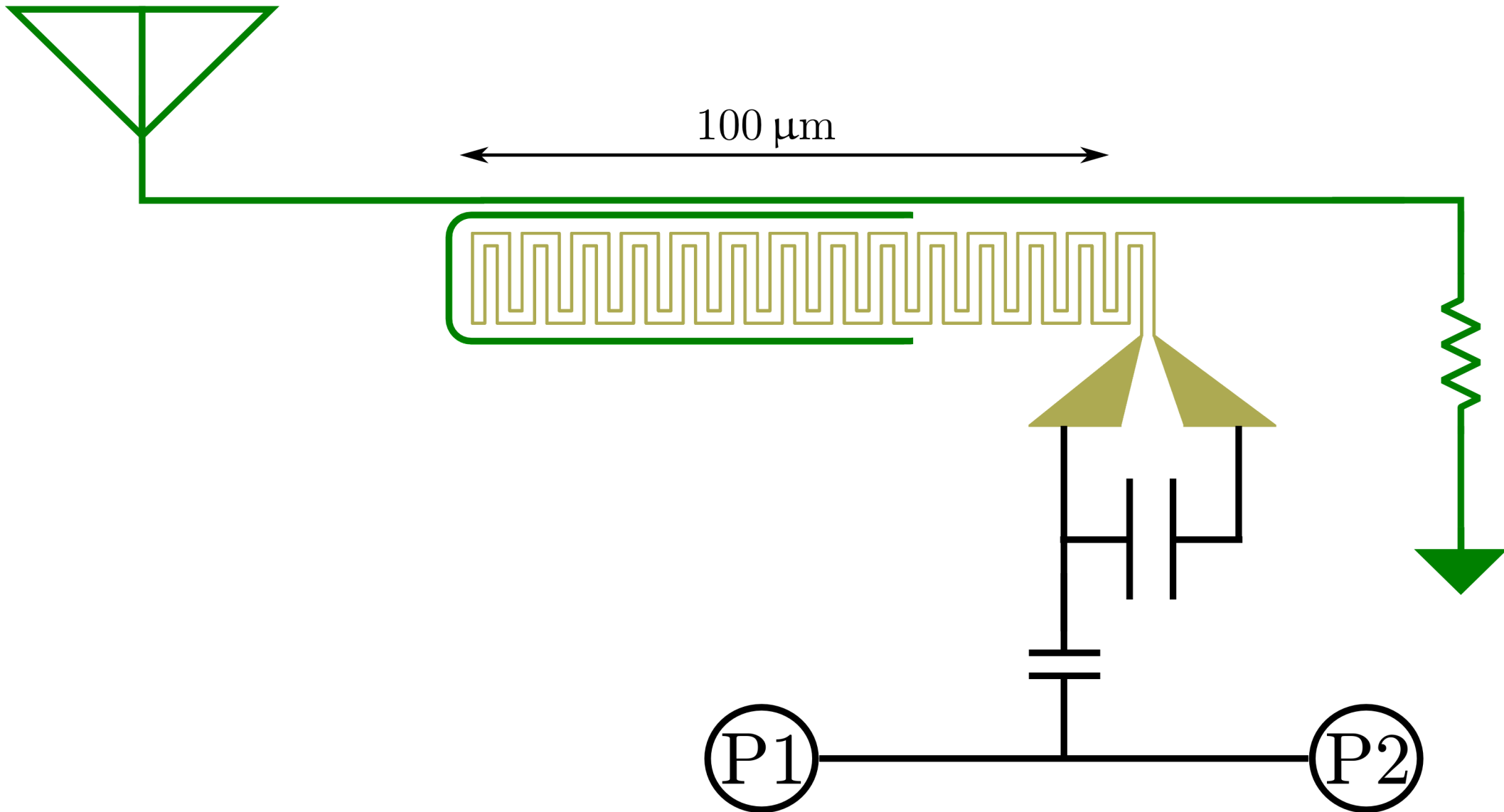


Tools: antennas and horns

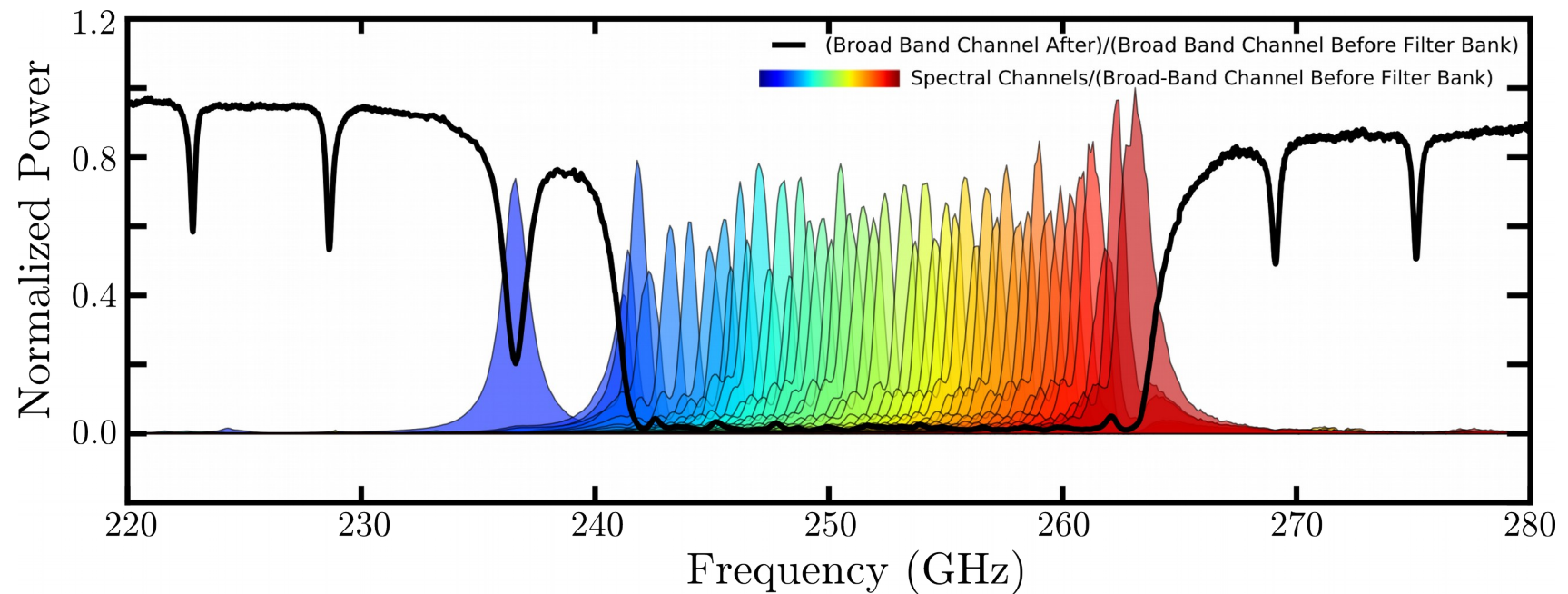
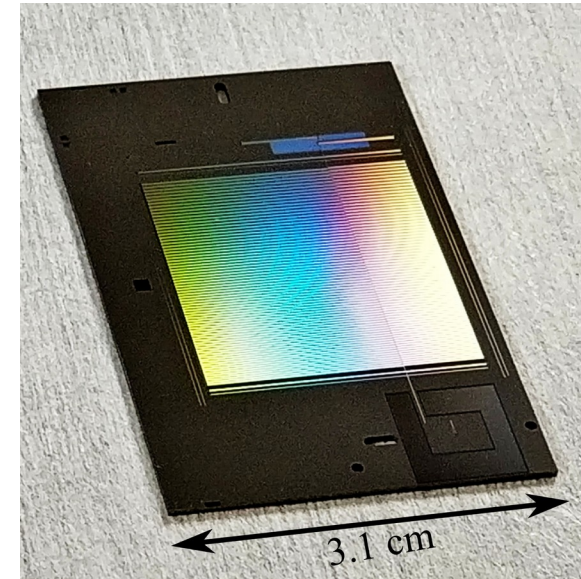
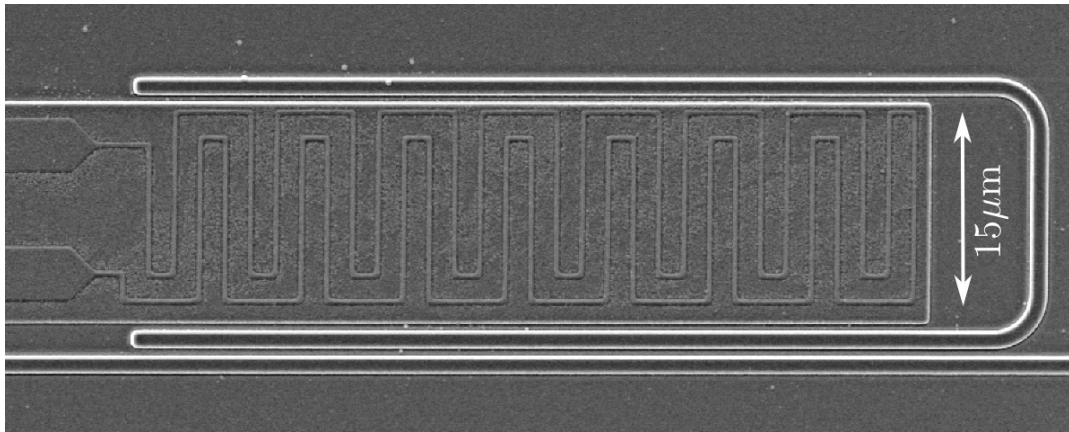


Some images: Advanced ACTPOL; SPT-3G

SuperSpec: on-chip spectroscopy using microstrip resonator filters

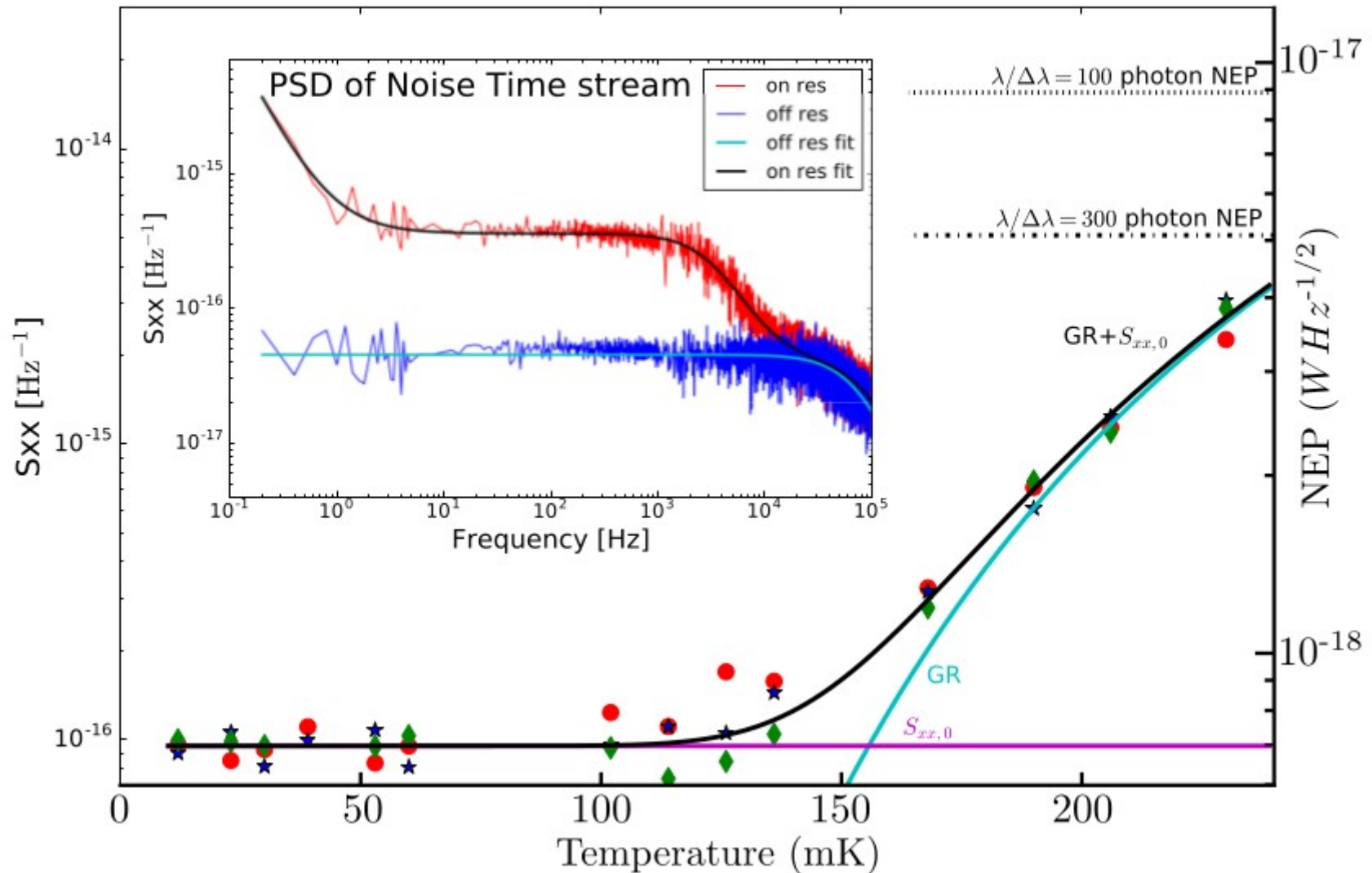


SuperSpec: an on-chip, $R=300$ spectrometer covering the 1 mm atmospheric band



Measured NEPs meet requirements for ground-based spectroscopy and submm/mm cameras.

Measured Detector Noise



Next steps for on-chip band definition: improving R

- How high can we go in resolving power?
 - Current devices are limited by dielectric loss in the material used for the microstrip.

$$1/R = 1/Q_c + 1/Q_i + 1/Q_{\text{loss}}$$

$$Q_{\text{loss}} = 1/\tan \delta$$

Efficient operation requires $R \lesssim Q_{\text{loss}}/3$

Currently $Q_{\text{loss}} \sim 1400$ for silicon nitride.

This limits R to a few hundred.

Lower loss materials exist:
amorphous sputtered Si, crystal Si

Currently working to: deliver $R=1000$, explore $R \sim 3000$

Next steps for on-chip band definition: higher frequencies

- How HIGH can we go in frequency?
 - Superconducting transmission lines stop working below

$$\nu_{\max} < 72 \text{ GHz} \frac{T_c}{1.0 \text{ K}}$$

Candidates:

Nb: 8-9 K, 600 GHz (500 microns)

NbN: ~14 K, 1.0 THz (300 microns)

NbTiN: ~16 K, 1.2 THz (250 microns)

Metamaterial dielectric “waveguide” could go even higher.

Currently working on:

Nb 850 and 650 micron devices

NbTiN or NbN at 350 and 250 microns

Next steps for everything: More sensitive detectors

- Several groups have measured NEPs of $\text{few} \times 10^{-19} \text{W/Hz}^{-1/2}$
- This is great for most sub-orbital applications.
- Work is ongoing to explore lower noise limits needed for cold space cameras, narrow suborbital bands
- This is technology-agnostic: similar detectors can be used behind a grating spectrograph, a horn array, or an antenna.

Conclusions

- Very large arrays of submm detectors will enable new classes of instruments.
- Kinetic inductance detectors have many useful properties and are now a mature technology.